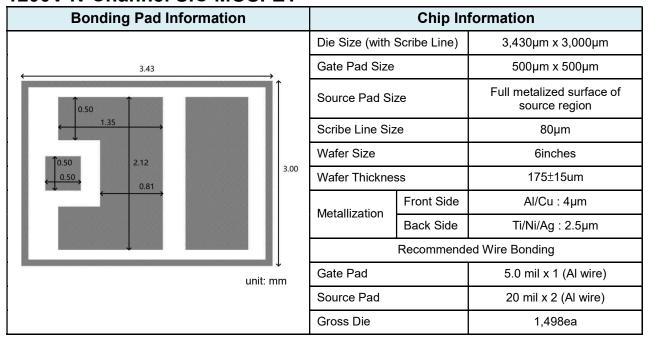
K UZYf GdYYJZJWUJcb G\ YYh HM120C75W

Silicon Carbide Metal-Oxide-Semiconductor Field-Effect Transistor 1200V N-Channel SiC MOSFET



Maximum Ratings (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	1200	V
Gate-Source Voltage	$V_{GS,op}$	-5/+20	V
Drain Current-Continuous @ Tc=25°C	l _D	47	А
Drain Current-Pulsed	I _{DM}	70	Α
Operating Junction Temperature Range	TJ	-55 to +175	°C

Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit		
OFF CHARACTERISTIC								
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =100uA	1200	-	-	V		
Drain-Source Leakage Current	I _{DSS}	V _{GS} =0V, V _{DS} =1200V	-	1	100	uA		
Gate-Source Leakage Current	Igss	V _{GS} =20V, V _{DS} =0V	-	10	250	nA		
ON CHARACTERISTIC								
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =5mA	1.8	2.8	3.8	V		
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =20V, I _D =20A	-	70	95	mΩ		
		V _{GS} =18V, I _D =20A	-	82	107			
DYNAMIC CHARACTERISTICS								
Input Capacitance	Ciss	V _{GS} =0V, V _{DS} =1000V, f=1MHz, V _{AC} =25mV	-	1450	-	pF		
Output Capacitance	Coss		-	66	-			
Reverse Transfer Capacitance	Crss		-	13	-			
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =-5V, I _S =10A	-	4.9	-	V		
	•	•	-	-	•	•		

NOTE

- 1. The data tested by pulsed, pulse with \leq 300us, duty cycle \leq 2%.
- 2. R_{DS(ON)} calculated by TO-247-3L package type.